

EAST Search History

EAST Search History (Prior Art)

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S1	33	colloidal with metal with porous with substrate	US-PGPUB; USPAT	OR	ON	2007/09/06 16:09
S2	5065	colloidal with metal with solution	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/09/06 16:10
S3	181	S2 and film and (porous with substrate)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/09/06 16:31
S4	4257	metal adj (colloid\$2 or sol)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/09/06 16:34
S5	0	S4 and (conductive adj film) and (porous adj substrate)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/09/06 16:32
S6	8	S4 and (conductive adj film) and (porous with substrate)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/09/06 16:32
S7	226	S4 and (porous with substrate)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/09/06 16:34
S8	48674	porous with substrate	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/09/08 16:57

S9	218	S8 and (colloid\$3 adj metal)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/09/08 16:57
S10	58	S9 and (conduct\$3 with (film or layer))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/09/08 16:58
S11	14039	porous adj substrate	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/09/08 16:57
S12	56	S11 and (colloid\$3 adj metal)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/09/08 16:57
S13	10	S12 and (conduct\$3 with (film or layer))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/09/08 16:58
S14	250	(organic with semiconductor) and (porous with electrode)	USPAT	OR	ON	2007/09/08 17:33
S15	26	(organic with semiconductor) and (porous adj electrode)	USPAT	OR	ON	2007/09/08 17:33
S16	5960	metal with colloid	US-PGPUB; USPAT	OR	ON	2008/02/04 15:02
S17	55	S16 and (metal with core) and (organic with shell)	US-PGPUB; USPAT	OR	ON	2008/02/04 15:03
S18	1	S17 and (drying with remov\$3 with organic)	US-PGPUB; USPAT	OR	ON	2008/02/04 15:04
S19	1	S17 and (dry\$3 with remov\$3 with organic)	US-PGPUB; USPAT	OR	ON	2008/02/04 15:05
S20	49	S17 and dry\$3	US-PGPUB; USPAT	OR	ON	2008/02/04 15:10

S21	651	(metal\$4 with colloid) and (organic with (solvent or substance)) and (dry\$3 with (air or infrared))	US-PGPUB; USPAT	OR	ON	2008/06/11 12:33
S22	141	S21 and (electrical\$5 with conductive)	US-PGPUB; USPAT	OR	ON	2008/06/11 12:37
S23	3752	metal with colloid	USPAT	OR	ON	2008/12/24 16:38
S24	1	("7398365").PN.	USPAT	OR	OFF	2008/12/27 16:43
S25	1	("7348365").PN.	USPAT	OR	OFF	2008/12/27 16:44
S26	4	("4629709" "5431967" "5560960" "5912069").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2008/12/27 16:55
S27	53	Nakatani.IN. and colloid \$3	US-PGPUB; USPAT	OR	ON	2008/12/27 16:57
S28	44	S27 and metal	US-PGPUB; USPAT	OR	ON	2008/12/27 16:57
S29	627	metal with colloid\$3 with ink	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/27 17:07
S30	63	metal with colloid\$3 with stabilization	USPAT	OR	ON	2008/12/27 17:40
S31	135	metal with colloid\$3 with ink	USPAT	OR	ON	2008/12/28 16:59
S32	64	S31 and (polymer with coat\$3)	USPAT	OR	ON	2008/12/28 17:01
S33	1	"4116910".PN.	USPAT; USOCR	OR	OFF	2008/12/29 10:53
S34	1	("6730400").PN.	USPAT; USOCR	OR	OFF	2008/12/30 11:57
S35	6474	438/584,597.598.ccls. or 257/E21.011,E21.161, E21.168,E21.585.ccls.	US-PGPUB; USPAT	OR	ON	2009/09/20 16:08
S36	749	438/584,597.598.ccls.	US-PGPUB; USPAT	OR	ON	2009/09/20 16:09
S37	2354	438/584,597,598.ccls.	US-PGPUB; USPAT	OR	ON	2009/09/20 16:09
S38	5784	257/E21.011,E21.161, E21.168,E21.585.ccls.	US-PGPUB; USPAT	OR	ON	2009/09/20 16:47
S39	2033	257/E21.011,E21.161. ccls.	US-PGPUB; USPAT	OR	ON	2009/09/20 16:48

S40	3919	257/E21.168,E21.585.ccls.	US-PGPUB; USPAT	OR	ON	2009/09/20 17:35
S41	748	257/E21.168.ccls.	US-PGPUB; USPAT	OR	ON	2009/09/20 17:35
S42	3225	257/E21.585.ccls.	US-PGPUB; USPAT	OR	ON	2009/09/20 17:49

EAST Search History (Interference)

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	0	((conduct\$3 or metal \$3 or ohmic) and (colloid or nano) and (porous or cellular or spongy) and shell and core and (substrate or workpiece) and dry \$3).CLM.	US-PGPUB; USPAT; UPAD	OR	ON	2009/09/21 11:54
L2	48	((conduct\$3 or metal \$3 or ohmic) and (colloid or nano) and (porous or cellular or spongy) and (substrate or workpiece) and dry \$3).CLM.	US-PGPUB; USPAT; UPAD	OR	ON	2009/09/21 11:56
L3	1	((conduct\$3 or metal \$3 or ohmic) and (colloid or nano) and (porous or cellular or spongy) and spin \$coat\$3 and (substrate or workpiece) and dry \$3).CLM.	US-PGPUB; USPAT; UPAD	OR	ON	2009/09/21 11:57

9/ 21/ 2009 11:59:17 AM**C:\ Documents and Settings\ asarkar\ My Documents\ EAST\ Workspaces\ 10-509698.w sp**